

# Technical Information

ModSTACK™ 6MS2400R17KE3-3WAH-B9C18VTIOIN



**Vorläufige Daten**  
preliminary data

## Key data

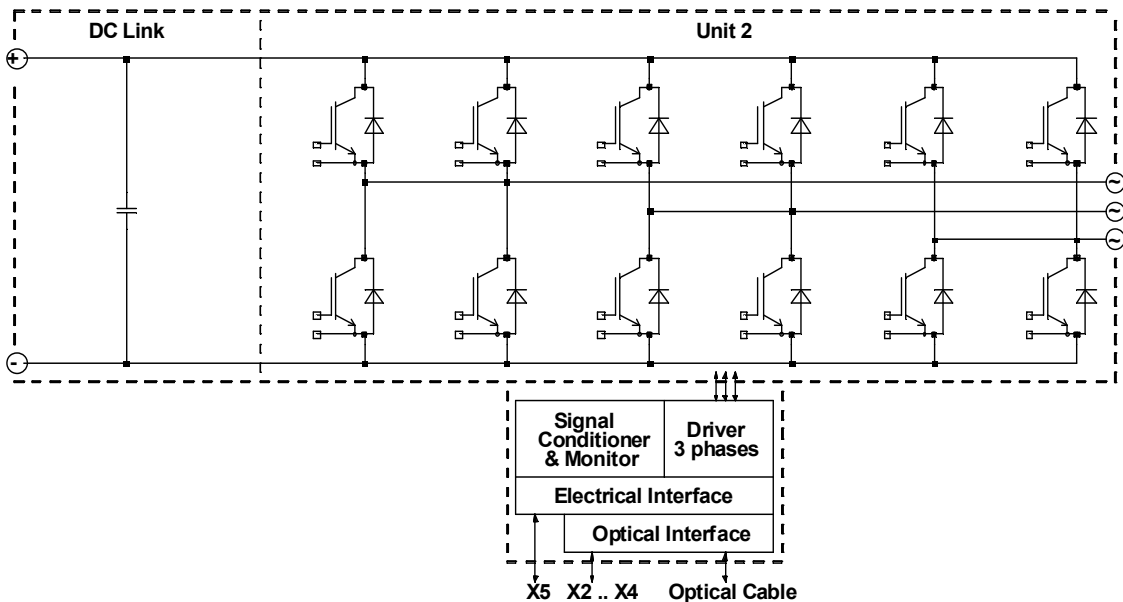
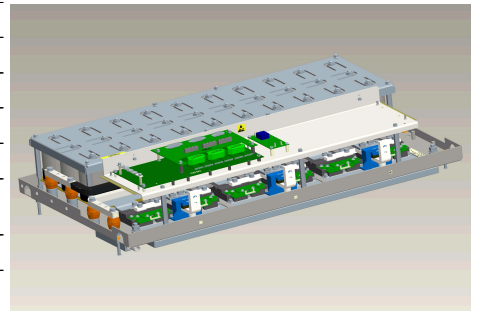
3x 1082A rms at 690V rms, water cooled

## General information

Stacks for various inverter application. Semiconductors, heat sinks, capacitors, drivers and sensors included. These are only technical data!

Please read carefully the complete documentation and maintain the proper design environment! Especially note the EMC environment and the controller's functionality.

Topology		DC Link + B6I
Application / Modulation		Inverter / Sine
Load type		resistive, inductive
Cooling		water cooled
Implemented sensors		current, voltage, temperature
Semicond. (Unit 1)		none
DC Link		12mF
Semicond. (Unit 2)	IGBT	6x FF1200R17KE3_B2
Driver signals IGBT		optical HFBR-15X1 / HFBR-25X1
Standards		EN50178
Sales - name		6MS24017E33W34402
Internal ID		34402
Mechanical drawing number		34402_MB
Electrical drawing number		57000008



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### Note

**Heat sink with aluminum cooling channel.**  
Composites of fluid: Water and 52 vol. % Antifrogen N.

### Electrical data

#### DC Link

			min	typ	max	units
Voltage		$V_{DC}$		1100	1250	V
Overvoltage shutdown	within 150µs			1250		V

#### Unit 2 AC

			min	typ	max	units
Voltage	depending on controller	$V_{Unit2}$		690		$V_{RMS}$
Continuous current	$V_{Unit2} = 690V_{RMS}$ , $V_{DC} = 1100V$ , $T_{inlet} = 40^{\circ}C$ , $T_J \leq 125^{\circ}C$ , $f_{Unit2} = 50Hz$ , $f_{sw2} = 2000Hz$ , $\cos(\phi) = 0,90$	$I_{Unit2}$			1082	$A_{RMS}$
Continuous current overload cap.	$T_{inlet} = 40^{\circ}C$ , for overload capability 150% for 60s			733		$A_{RMS}$
Short time current	$T_{inlet} = 40^{\circ}C$ , 10s, every 180s, initial load = 930 $A_{RMS}$	$I_{Unit2}$			1162	$A_{RMS}$
DC current	no rotating field, $T_{inlet} = 40^{\circ}C$	$I_{Unit2 DC}$			509,0	$A_{av}$
Overcurrent shutdown	within 15µs			1700		$A_{peak}$
Switching frequency		$f_{sw2}$			3000	Hz
Power losses	$V_{Unit2} = 690V$ , $V_{DC} = 1100V$ , $T_{inlet} = 40^{\circ}C$ , $T_J \leq 125^{\circ}C$ , $f_{Unit2} = 50Hz$ , $f_{sw2} = 2000Hz$ , $\cos(\phi) = 0,90$ , $I_{Unit2} = 1082A_{RMS}$	$P_{loss2}$		13300		W
Power factor		$\cos(\phi)_{Unit2}$	-1,00		1,00	

#### General data

			min	typ	max	units
Power losses (PCB and capacitor)		$P_{loss aux}$			400	W
EMC test	according to IEC61800-3 at named interfaces	power	$V_{Burst}$	2		kV
		control	$V_{Burst}$	1		kV
		aux (24V)	$V_{Surge}$	1		kV
Insulation management is designed for		$V_{Line}$		690		$V_{RMS}$
Insulation test voltage	according to EN50178, $f = 50Hz$ , $t = 60s$	$V_{isol}$		2,5		$kV_{RMS}$

#### Important component data

			min	typ	max	units
DC Link capacitor		$C_{DC}$		12,00		mF
		type		Foil		
Temperature range			-40		+85	$^{\circ}C$
Rated voltage	per device	$U_R$		1100		$V_{DC}$
Surge voltage	per device	$U_{Surge}$			1650	V
Rated capacitance	per device	$C_R$		400		$\mu F$
Capacitance tolerance	per device	Tol	-10		+10	%
Maximum ripple current	per device, $T_{amb} = 60^{\circ}C$	$I_{Rmax}$			45	$A_{RMS}$
wiring system	series, parallel			1s, 30p		
Balance or discharge resistors	per DC Link unit	$R_b$		6,0		k $\Omega$

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### Controller interface data

			min	typ	max	units
Auxiliary voltage		$V_{aux}$	18	24	30	$V_{av}$
Auxiliary power requirement	$V_{aux} = 24V_{av}$	$P_{aux}$	40			W
Driver and interface board	see separate technical information		TR110 / DR110			
Driver core			EiceDRIVER 2ED300C17-S			
Digital input level	resistor to GND 1,8k $\Omega$ , capacitor to GND 4nF, high = on, min 15mA	$V_{in}$	0,0		15,0	V
Digital output level	open collector, low = ok, max 15mA	$V_{out}$	0,0		15,0	V
Analog current outputs Unit 2	load max 1mA; at 1000A	$V_{ana out}$	5,01	5,11	5,21	V
Analog DC Link voltage output	load max 1mA; at 1250V	$V_{DC out}$	8,79	8,97	9,15	V
Analog temperature output	load max 1mA; at $T_{NTC} = 68^{\circ}C$ correspond to $T_j = 125^{\circ}C$	$V_{T out}$	9,11	9,30	9,49	V
Overtemperature shutdown	at $T_{NTC} = 72^{\circ}C$ correspond to $T_j = 133^{\circ}C$	$V_{T out OT}$		10		V
Optical interface board	see separate technical information		OEA101			
Optical input power				12		$\mu W$
Optical output power					60	$\mu W$

### Heat sink water cooled / Thermal data

			min	typ	max	units
Water flow	according cooling water specification from infineon	$\Delta V / \Delta t_{Water}$	12			dm <sup>3</sup> /min
Water pressure drop		$\Delta p_{Water}$		400		mbar
Water pressure					8	bar
Cooling water inlet temperature		$T_{inlet}$	-25		40	$^{\circ}C$
Water connection				3/4		in

### IGBT data unit 2

			min	typ	max	units
Type	assumed					
collector-emitter saturation voltage	$I_c = 1200A; V_{ge} = 15V; T_{vj} = 125^{\circ}C$	$V_{CE sat}$		2,4		V
parameter for linear model	$T_{vj} = 25^{\circ}C$	$V_{ce1}$		1,1		V
parameter for linear model	$T_{vj} = 25^{\circ}C$	$r_{ce1}$		0,75		m $\Omega$
parameter for linear model	$T_{vj} = 125^{\circ}C$	$V_{ce2}$		1		V
parameter for linear model	$T_{vj} = 125^{\circ}C$	$r_{ce2}$		1,167		m $\Omega$
turn-on / turn-off energy loss per pulse	$T_{vj} = 25^{\circ}C$	$E_1$		240 / 305		mJ
turn-on / turn-off energy loss per pulse	$T_{vj} = 125^{\circ}C$	$E_2$		350 / 445		mJ
thermal resistance, junction to case	per IGBT	$R_{thjc}$		0,019		K/W
thermal resistance, case to heatsink	per IGBT	$R_{thch}$		0,023		K/W

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### Diode data unit 2

			min	typ	max	units
Type	assumed					
forward voltage	$I_F = 1200A; V_{ge} = 0V; T_{vj} = 125^\circ C$	$V_F$		1,9		V
parameter for linear model	$T_{vj} = 25^\circ C$	$V_{F1}$		1,15		V
parameter for linear model	$T_{vj} = 25^\circ C$	$r_{F1}$		0,542		mΩ
parameter for linear model	$T_{vj} = 125^\circ C$	$V_{F2}$		1		V
parameter for linear model	$T_{vj} = 125^\circ C$	$r_{F2}$		0,75		mΩ
reverse recovery energy	$T_{vj} = 25^\circ C$	$E_{rec1}$		190		mJ
reverse recovery energy	$T_{vj} = 125^\circ C$	$E_{rec2}$		340		mJ
thermal resistance, junction to case	per Diode	$R_{thjc}$		0,042		K/W
thermal resistance, case to heatsink	per Diode	$R_{thch}$		0,052		K/W

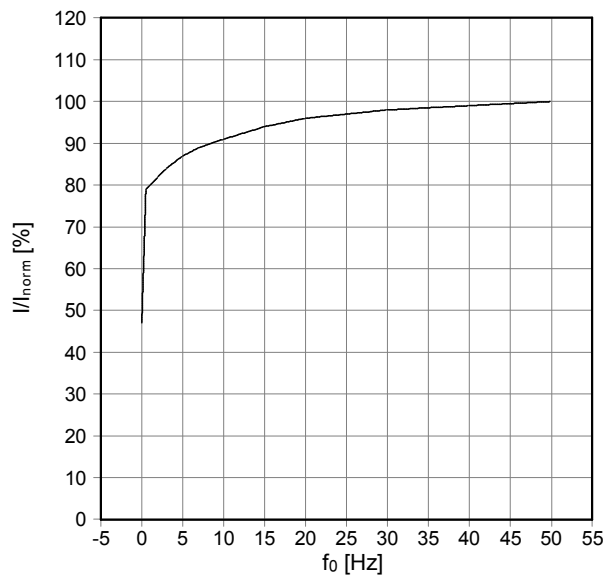
### Environmental conditions

			min	typ	max	units
Storage temperature		$T_{stor}$	-40		65	°C
Ambient temperature	minimum 0°C for optional optical interface	$T_{amb}$	-25		55	°C
Operating temperature	see chapter Heat sink water cooled / Thermal data					
Cooling air velocity (PCB and capacitor)		$V_{Air PCB}$	2,0			m/s
Air pressure	standard atmosphere	$p_{Air}$	900		1100	hPa
Humidity	no condensation	Rel. F	0		95	%
Installation height			0		1000	m
Vibration	according to EN60068				10	m/s <sup>2</sup>
Continuous vibration	according to EN60068				20	m/s <sup>2</sup>
Shock	according to EN60068				100	m/s <sup>2</sup>
Protection degree				IP00		
Pollution degree				2		
Dimensions	width × depth × height		1090	596	257	mm
Weight with heat sink	approximation			83,0		kg
Weight without heat sink	approximation			65,0		kg

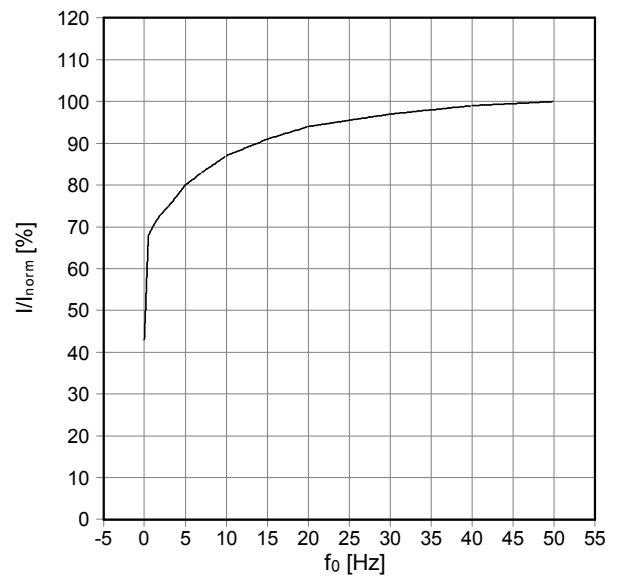
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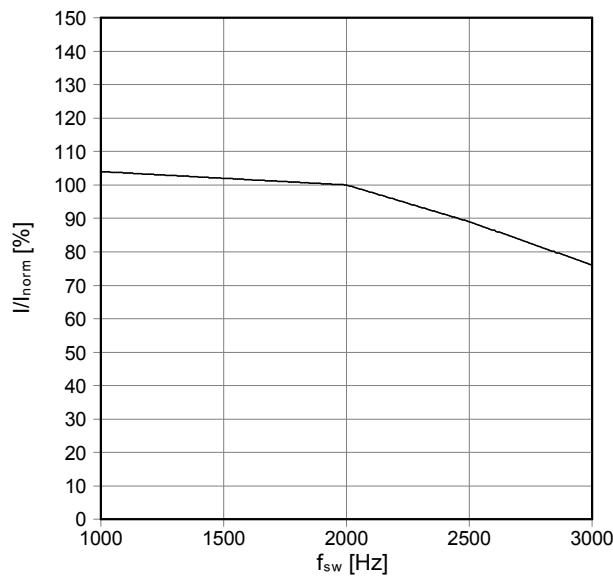
**fo - derating curve IGBT (motor)**  
 $\cos(\phi) = 0,90$   
 $T_{cool\ medium} = 40^{\circ}C$  ; 100% = 1082 A rms



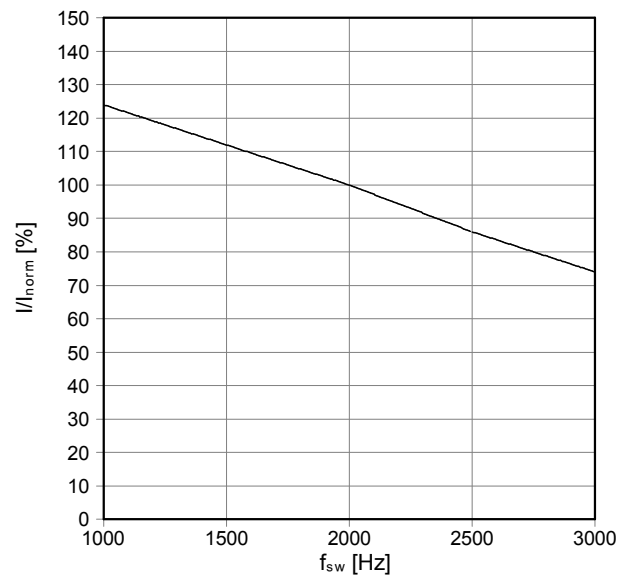
**fo - derating curve Diode (generator)**  
 $\cos(\phi) = -0,90$   
 $T_{cool\ medium} = 40^{\circ}C$  ; 100% = 904 A rms



**fsw - derating curve IGBT (motor)**  
 $\cos(\phi) = 0,90$   
 $T_{cool\ medium} = 40^{\circ}C$  ; 100% = 1082 A rms

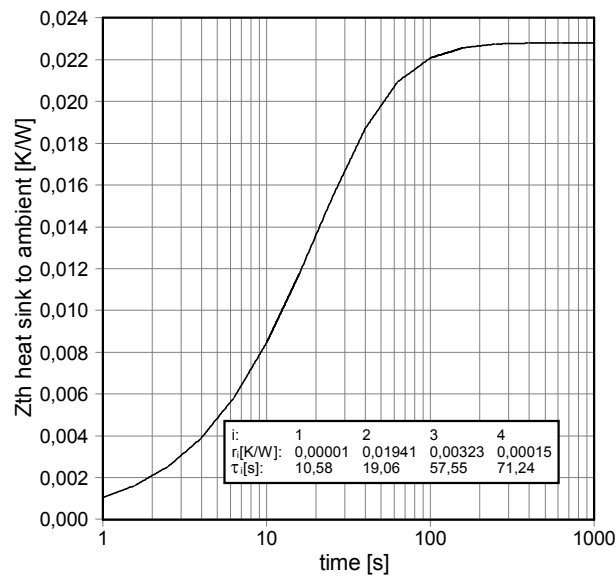


**fsw - derating curve Diode (generator)**  
 $\cos(\phi) = -0,90$   
 $T_{cool\ medium} = 40^{\circ}C$  ; 100% = 904 A rms



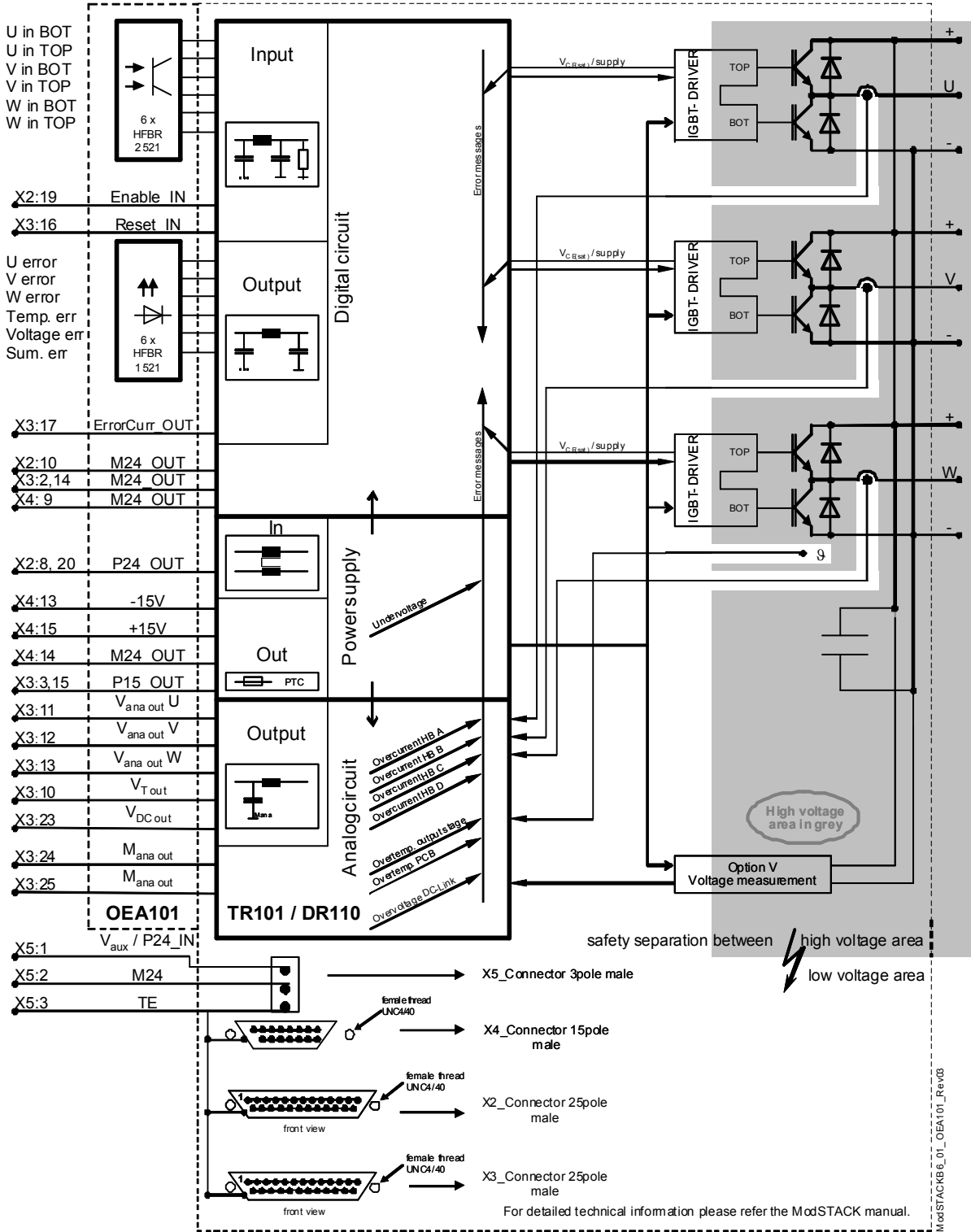
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Transient thermal impedance per module  
T<sub>cool medium</sub> = 40°C



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Circuit diagram



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- den Abschluss von speziellen Qualitätssicherungsvereinbarungen;
- die gemeinsame Einführung von Maßnahmen zu einer laufenden Produktbeobachtung dringend empfehlen und gegebenenfalls die Belieferung von der Umsetzung solcher Maßnahmen abhängig machen.

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Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify. Please note, that for any such applications we urgently recommend

- to perform joint Risk and Quality Assessments;
- the conclusion of Quality Agreements;
- to establish joint measures of an ongoing product survey, and that we may make delivery depended on the realization of any such measures.

If and to the extent necessary, please forward equivalent notices to your customers.

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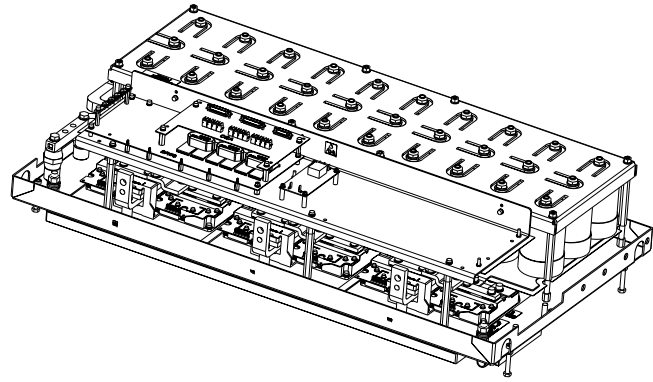
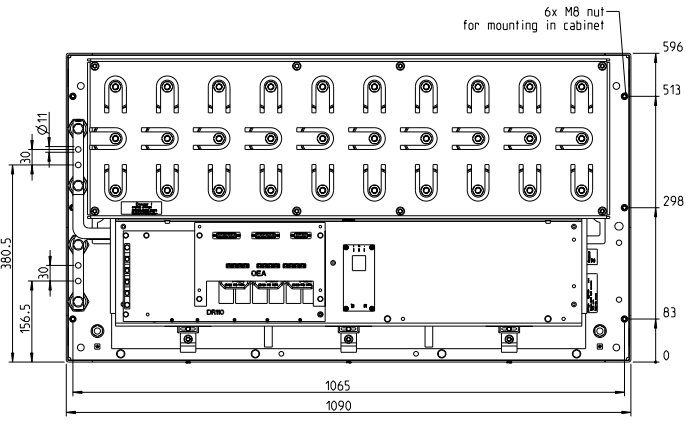
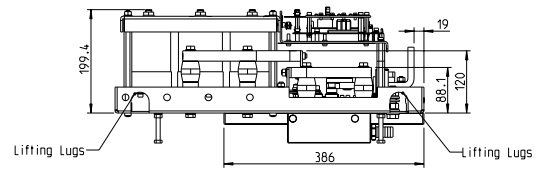
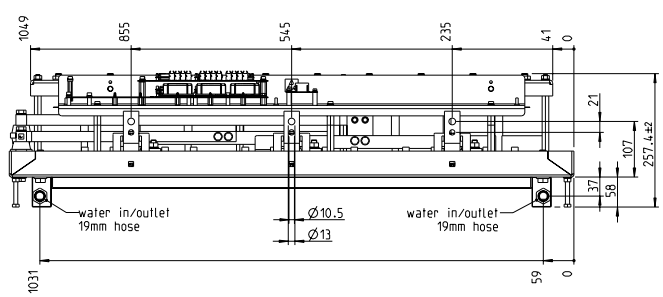
### **Sicherheitshinweise**

Bevor Sie mit der Installation und dem Betrieb der Baugruppe beginnen, lesen Sie bitte sorgfältig alle Sicherheitshinweise, Warnungen und beachten Sie die angebrachten Warnschilder. Vergewissern Sie sich, dass alle Warnschilder in leserlichem Zustand verbleiben und fehlende oder beschädigte Schilder ersetzt werden.

### **Safety Instructions**

Prior to installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced. To installation and operation, all safety notices and warnings and all warning signs attached to the equipment have to be carefully read. Make sure that all warning signs remain in a legible condition and that missing or damaged signs are replaced.

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Part-No. 34402	general	Interface	Surface	Scale 1:5
Assembly-No.			Material	
		Date	Name	Description
	Agent	19.09.2009	Heiner	Outline MS3 GMSxx00Rxx xxx-3W CH-Cxx
	Checked by	09.2009	see below	
	Norm.			
				Graph-No. 34402
Vers.	Revision	Date	Name (Origin)	Version Sheet 0 1/2 A2
				Constructed for

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